MECHANICAL CASE OUTLINE
PACKAGE DIMENSIONS

WQFNW31, 5x5, 0.5P
CASE 512AE
ISSUE B

NOTES:
2. CONTROLLING DIMENSION MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 MM FROM THE TERMINAL TIP.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

DETAIL B
SEATING PLANE

NOTE 4

DETAIL A

EXPOSED COPPER

MECHANICAL CASE OUTLINE
PACKAGE DIMENSIONS

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